

# Closing



#### March 3 - 6, 2013

# **WRAP-UP**



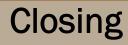
























#### **AWARDS / CLOSING REMARKS**

#### by

Fred Taber General Chairman, BiTS Workshop

**t's been three days** packed with learning, exploring and sharing, but now it's time to pack our bags and take what we've learned back to our jobs. But first, there are a few closing remarks and some recognition to the people and papers that have distinguished themselves in one way or another at BiTS 2013.

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### Become an Author or Instructor

**TechTalk Proposals** 



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### \*\*\* Abstracts for Papers & Posters \*\*\*

Contact: Mike Noel or Fred Taber Or any committee member





FOURTEENTH  $14^{
m th}$  annual

# Closing

## Save the Date

BiTS 2012 March 9 - 12, 2014 at the Hilton



**AWARDS** 



- Best Poster
- Best Data Presented
- Most Inspirational Paper
- Best Presentation, Tutorial in Nature
- Attendee Choice
- Best Presentation / Paper
- AND.....the Special Award......



# Closing





#### **PROGRAM:**

Rafiq Hussain—AMD (ret.) Marc Knox—IBM

C.Y. Lai—TTS Group Mike Noel—Freescale Ila Pal—Ironwood Electronics

**Terrific Job!** Morten Jensen—Intel Joachim Moerbt—Advantest John Moore—Texas Instruments Ira Feldman—Feldman Eng. Corp.

Committee

LOCAL ARRANGEMENTS:

Valts Treibergs, Chair—Multitest

**Owen Prillaman**—TechConnect Sales & Distribution

**MARKETING:** 

John Hartstein, Chair—Sensata

**REGISTRATION:** 

Paul Boyce, Chair—Advantage Specialist





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# Closing



### **Speakers**

# THANK YOU

**Keynote Speaker** 

Bill McClean IC Insights, Inc.

### **Talking Points**

Françoise von Trapp Founder of 3D InCites

